PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kazuhito OGINO	06/08/2010
Toshihiko IIJIMA	06/08/2010
Kaori ARAI	06/18/2010

RECEIVING PARTY DATA

Name:	TOKYO ELECTRON LIMITED
Street Address:	3-1 Akasaka 5-chome, Minato-ku,
City:	Tokyo
State/Country:	JAPAN
Postal Code:	107-6325

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12817876

CORRESPONDENCE DATA

Fax Number: (860)286-0115

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 860-286-2929

Email: jlee@cantorcolburn.com

Correspondent Name: CANTOR COLBURN, LLP

Address Line 1: 20 Church Street
Address Line 2: 22nd Floor

Address Line 4: Hartford, CONNECTICUT 06103

ATTORNEY DOCKET NUMBER:	TKE0046US
NAME OF SUBMITTER:	Daniel P. Lent

Total Attachments: 2 source=43Q9434#page1.tif

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PATENT REEL: 024893 FRAME: 0417

ASSIGNMENT

WHEREAS We, Kazuhito OGINO of c/o TOKYO ELECTRON AT LIMITED, 2381 -1 Kitagejo, Fujii-cho, Nirasaki City, Yamanashi 407-8511, Japan, Toshihiko IIJIMA of c/o T OKYO ELECTRON TS LIMITED, 2381-1 Kitagejo, Fujii-cho, Nirasaki City, Yamanashi 40 7-8511, Japan, and Kaori ARAI of TOKYO ELECTRON TS LIMITED, 2381-1 Kitagejo, Fu jii-cho, Nirasaki City, Yamanashi 407-8511, Japan (hereinafter referred to as "ASSIGNORS") have invented certain new and useful improvements in:

PRE-ALIGNMENT METHOD OF SEMICONDUCTOR WAFER AND COMPUTER-READA BLE RECORDING MEDIUM HAVING PRE-ALIGNMENT PROGRAM RECORDED THER EON

which claims priority to Japanese Application No. 2009-147059, filed June 19, 2009, and for which we are about to file or have filed an application for Letters Patent of the United States;

AND WHEREAS, TOKYO ELECTRON LIMITED (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Japan, having a place of business at 3-1 Akasaka 5-chome, Minato-ku, Tokyo 107-6325, Japan, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the

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PATENT REEL: 024893 FRAME: 0418 sole use and behoof of ASSIGNEE, its successors and assigns; and I do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that I will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: Jun. 8,2010	Kazukito Ogino Kazukito OGINO	L.S.
Date: June 8th, 2010	Joshihiko Dijima Toshihiko IIJIMA	L.S.
Date: June . 18. 20/0	Kaori Arai Kaori ARAI	L.S.

RECORDED: 08/26/2010